

Clock OSC

SG3225VAN

SEIKO EPSON CORPORATION

Product name SG3225VAN 133.333000MHz KJGA
 Product Number / Ordering code X1G0042410136xx

Please refer to the 9.Packing information about xx (last 2 digits)

Output waveform LVDS

Pb free / Complies with EU RoHS directive

Reference weight Typ. 25 mg

1.Absolute maximum ratings

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions / Remarks
Maximum supply voltage	V _{cc-GND}	-0.3	-	+4	V	-
Storage temperature	T _{stg}	-40	-	+125	°C	Storage as single product
Input voltage	V _{in}	-0.3	-	V _{cc} +0.3	V	OE Terminal

2.Specifications(characteristics)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions / Remarks
Output frequency	f ₀	-	133.3330	-	MHz	
Supply voltage	V _{cc}	2.25	-	3.63	V	-
Operating temperature	T _{use}	-40	-	+85	°C	-
Frequency tolerance	f _{tol}	-50	-	50	x10 ⁻⁶	-
Current consumption	I _{cc}	-	-	30	mA	OE = V _{cc} , L_LVDS = 100 Ω
Stand-by current	I _{std}	-	-	-	mA	-
Disable current	I _{dis}	-	-	20.0	mA	OE = GND
Symmetry	SYM	45	-	55	%	At output crossing point
Output voltage(LVDS)	V _{OD}	250	-	450	mV	-
	dV _{OD}	-	-	50	mV	-
	V _{OS}	1.15	-	1.35	V	-
	dV _{OS}	-	-	150	mV	-
Output load condition(LVDS)	L_LVDS	-	100	-	Ω	Connected between OUT and $\overline{\text{OUT}}$
Input voltage	V _{IH}	70 % V _{cc}	-	-		-
	V _{IL}	-	-	30 % V _{cc}		-
Rise time	t _r	-	-	300	ps	-
Fall time	t _f	-	-	300	ps	-
Start-up time	t _{str}	-	-	3	ms	-
Jitter	t _{DJ}	-	5.6	-	ps	Deterministic Jitter V _{cc} =2.5V
	T _{RJ}	-	1	-	ps	Random Jitter V _{cc} =2.5V
	t _{RMS}	-	5.2	-	ps	δ(RMS of total distribution) V _{cc} =2.5V
	t _{p-p}	-	21.8	-	ps	Peak to Peak V _{cc} =2.5V
	t _{acc}	-	1.1	-	ps	Accumulated Jitter(5) n=2 to 50000 cycles V _{cc} =2.5V
Phase jitter	t _{PJ}	-	0.43	-	ps	Offset Frequency: 12kHz to 20MHz V _{cc} =2.5V
Phase noise	L(f)	-	-47	-	dBc/Hz	Offset 1Hz V _{cc} =2.5V
		-	-83	-	dBc/Hz	Offset 10Hz V _{cc} =2.5V
		-	-109	-	dBc/Hz	Offset 100Hz V _{cc} =2.5V
		-	-124	-	dBc/Hz	Offset 1kHz V _{cc} =2.5V
		-	-133	-	dBc/Hz	Offset 10kHz V _{cc} =2.5V
		-	-137	-	dBc/Hz	Offset 100kHz V _{cc} =2.5V
		-	-135	-	dBc/Hz	Offset 1MHz V _{cc} =2.5V
Frequency aging	f _{age}	-5	-	5	x10 ⁻⁶ /Year	25 °C, 1st year
		-	-	-		-

3. Test circuit

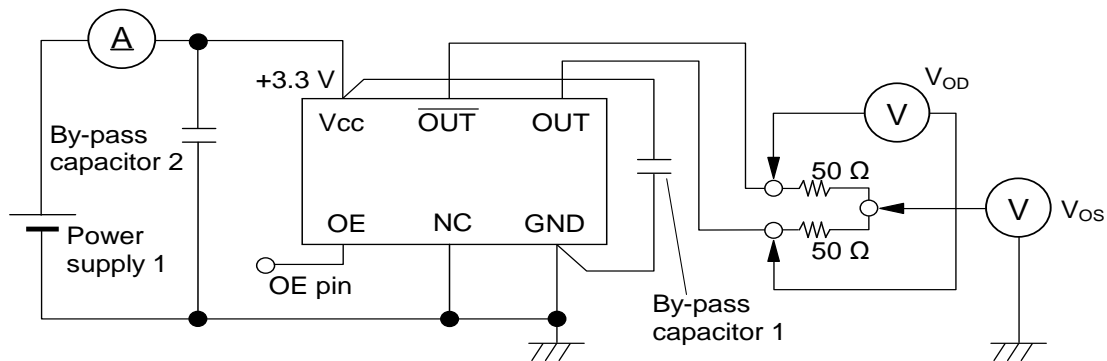
1) To observe waveform and current (case 1)



* The lines from OUT and $\overline{\text{OUT}}$ pin are same length.

* To measure the disable current, OE pin is connected to GND

2) To observe waveform and current (case 2)



* The lines from OUT and $\overline{\text{OUT}}$ pin are same length.

3) Measurement condition

A) Oscilloscope

- Bandwidth should be 5 times higher than DUT's output frequency (4 GHz).
- Probe ground should be placed closely from test point and lead length should be as short as possible.

B) By-pass capacitor 1 (approx. 0.01 μF to 0.1 μF) places closely between Vcc and GND.

C) By-pass capacitor 2 (approx. 10 μF) places closely between power supply terminals on the board.

D) Use the current meter whose internal impedance value is small.

E) Power supply

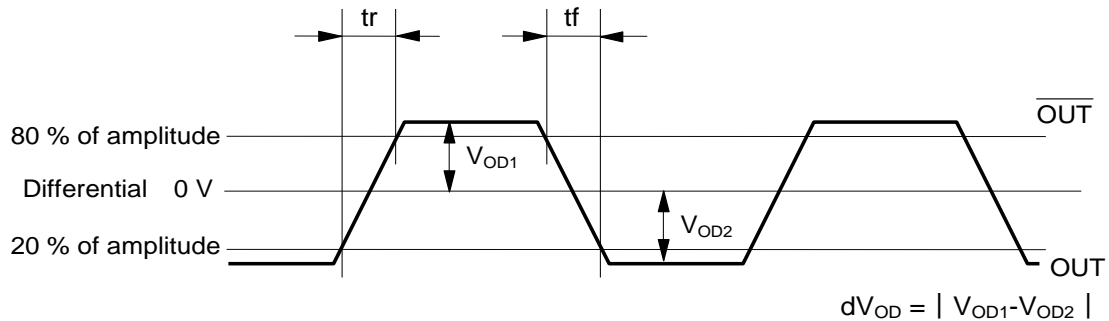
- Start up time (0 Vg90 %Vcc) of power source should be more than 150 μs and slew rate should be less than 19.8 mV/ μs .
- Impedance of power supply should be as low as possible.

4. Timing chart

Each output waveform (OUT, and $\overline{\text{OUT}}$)

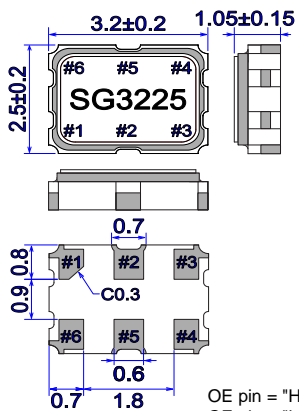


Differential output waveform ($\text{OUT} - \overline{\text{OUT}}$)



5. External dimensions

(Unit: mm)



Pin	Connection
1	OE
2	N.C.
3	GND
4	OUT
5	$\overline{\text{OUT}}$
6	VCC

OE pin = "H" or "open" : Specified frequency output.
 OE pin = "L" : Output is high impedance.
 #2 pin connection = GND is acceptable.
 The metal cap is connected to #3 pin.

6. Footprint (Recommended)

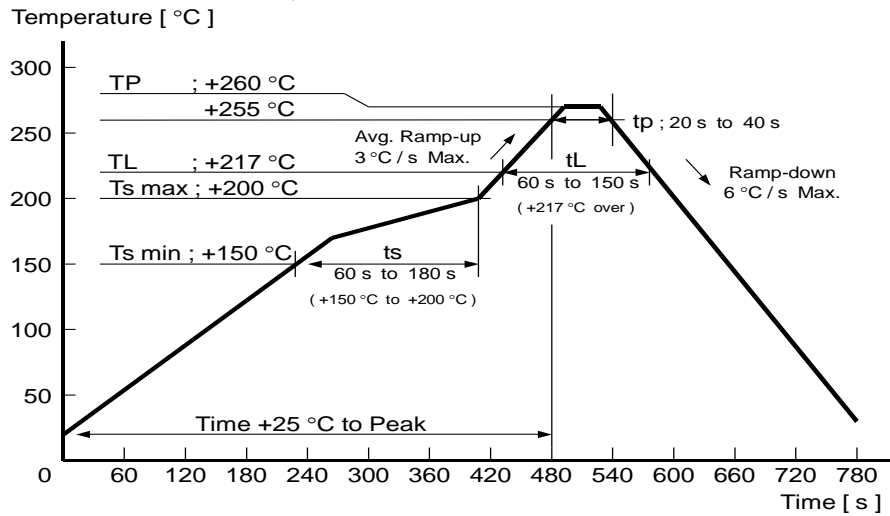
(Unit: mm)



To maintain stable operation, provide a 0.01 μF to 0.1 μF by-pass capacitor at a location as near as possible to the power source terminal of the crystal product (between V_{cc} - GND).

7. Reflow profile

Reflow condition (Follow of JEDEC STD-020D.01)

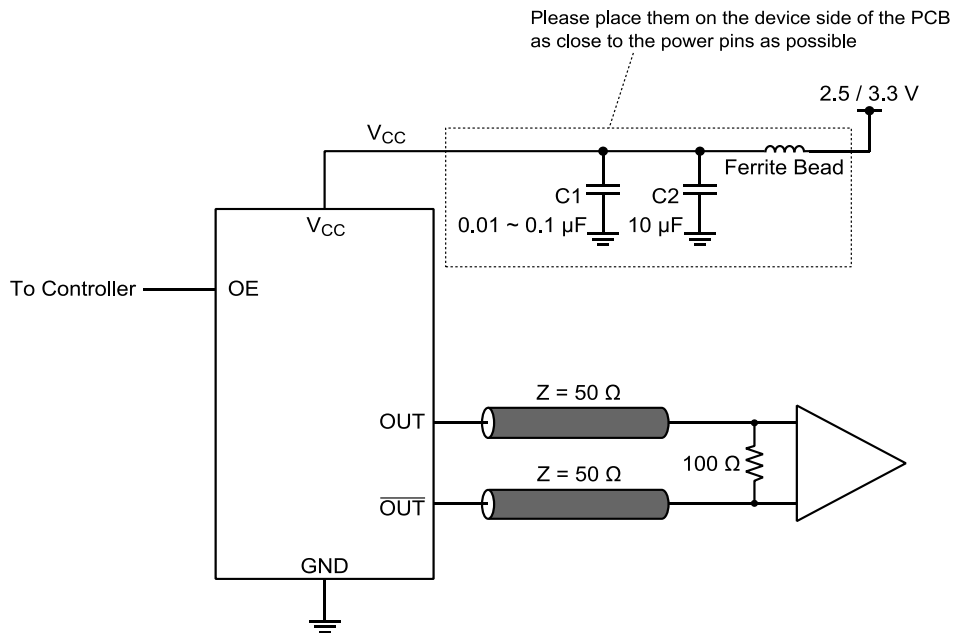


8. Example of schematic layout

This figure shows an example of this product's application schematic.

As with any high speed analog circuitry, the power supply pins for this device are vulnerable to noise. In order to achieve optimum jitter performance, power isolation with filter device is required for power supply pins.

In order to achieve best performance of the power isolation filter, it is recommended that the filter composing devices is placed on the device side of the PCB as close to the power pins as possible. The component value of this filter is just an example, it may have to be adjusted.



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- * By-pass capacitor (approx. 0.01 μ F to 0.1 μ F) places closely between Vcc and GND.
- * By-pass capacitor (approx. 10 μ F) places closely between power supply terminals on the board.
- * Please design the two output lines by characteristic impedance 100 Ω and same length, and try to make the output lines as short as possible.

9.Packing information

[1] Product number last 2 digits code(xx) description

The recommended code is "00"

X1G0042410136xx

Code	Condition	Code	Condition
01	Any Q'ty vinyl bag(Tape cut)	13	500pcs / Reel
11	Any Q'ty / Reel	14	1000pcs / Reel
12	250pcs / Reel	00	2000pcs / Reel

[2] Taping specification

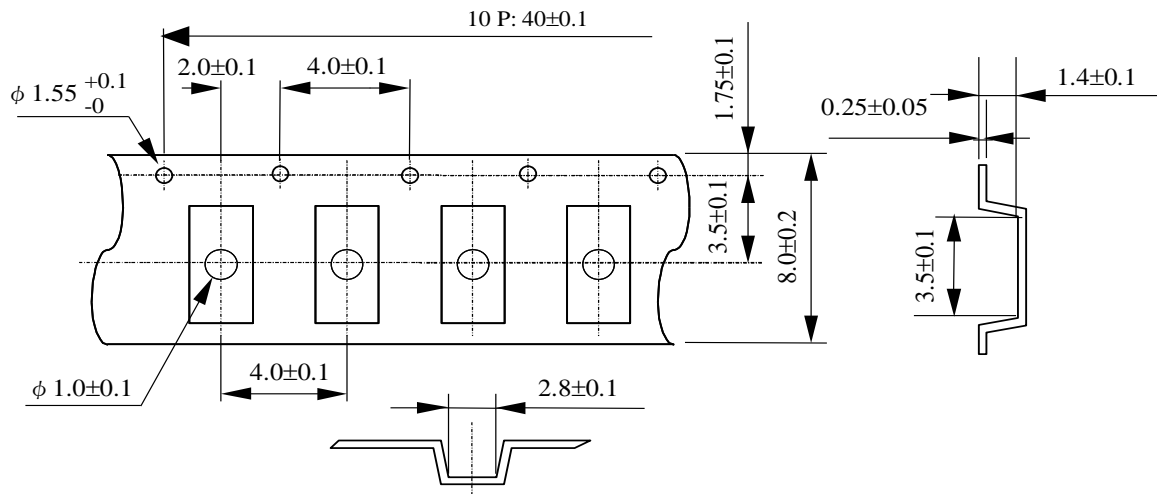
Subject to EIA-481 & IEC-60286

(1) Tape dimensions

Material of the Carrier Tape : PS

Material of the Top Tape : PET+PE

Unit: mm



(2) Reel dimensions

Center material : PS

Material of the Reel : PS



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